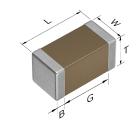
## 积层贴片陶瓷片式电容器

## C1608JB1E106M080AC

RoHS Reach Halogen Free Pb Free

交货型号	C1608JB1E106MT****	
用途	一般等级	
特点	General 一般(~75V)	
系列	C1608 [EIA 0603]	
状态	金 量产体制(新设计非推荐) 推荐代替型号 : <u>C1608X5R1E106M080AC</u> (不保证其兼容性。)	



尺寸		
长度(L)	1.60mm ±0.20mm	
宽度(W)	0.80mm ±0.20mm	
厚度(T)	0.80mm ±0.20mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.30mm Min.	
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)	
1世存序益型/JQ (FA)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)	
JETT/FT.III.1H/III (LD)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)	
1年行/十二/甲/四 は 0/	0.60mm to 0.80mm(Reflow Soldering)	

电气特性			
电容	$10\muF~\pm20\%$		
额定电压	25VDC		
温度特性	JB (±10%)		
耗散因数(Max.)	10%		
绝缘电阻(Min.)	10M Ω		

	其他	
焊接方法	流体	
<b>异按</b> 月伝	回流	
AEC-Q200	NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

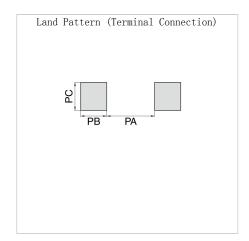
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## Associated Images



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